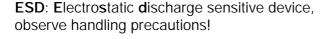


HiRel NPN Silicon RF Transistor

- HiRel Discrete and Microwave Semiconductor
- For Low Current Applications
- For Oscillators up to 12 GHz
- Noise Figure F = 1.15 dB at 1.8 GHz
 Outstanding Gms = 23dB at 1.8 GHz
- Hermetically sealed microwave package
- Transition Frequency $f_T = 20 \text{ GHz}$
- SIEGET 25-Line Infineon Technologies Grounded Emitter Transistor-25 GHz f_T-Line
- **@esa** Space Qualified

ESA/SCC Detail Spec. No.: 5611/008

Type Variant No. 01

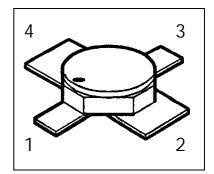


Туре	Marking	Ordering Code	Pin Configuration			Package	
			1	2	3 4	ļ	
BFY405 (ql)	-	see below	С	Е	В	Е	Micro-X

(ql) Quality Level: P: Professional Quality, Ordering Code: Q62702F1661

H: High Rel Quality,
S: Space Quality,
ES: ESA Space Quality,
Ordering Code: on request
Ordering Code: Q62702F1710

(see order instructions for ordering example)





Maximum Ratings

Parameter	Symbol	Values	Unit				
Collector-emitter voltage	V _{CEO}	4.5	V				
Collector-base voltage	V _{CBO}	15	V				
Emitter-base voltage	V _{EBO}	1.5	V				
Collector current	I _C	12	mA				
Base current	I _B	1.0	mA				
Total power dissipation, $T_S \le 145^{\circ}C^{-1), 2)}$	P _{tot}	55	mW				
Junction temperature	Tj	175	°C				
Operating temperature range	T _{op}	-65+175	°C				
Storage temperature range	T_{stg}	-65+175	°C				
Thermal Resistance							
Junction-soldering point 2)	R _{th JS}	< 545	K/W				

- Notes.: 1) At T_S = + 145 °C. For T_S > + 145 °C derating is required.
- 2) T_s is measured on the collector lead at the soldering point to the pcb.

Electrical Characteristics

at T_A=25°C; unless otherwise specified

Parameter	Symbol	Values		Unit		
		min.	typ.	max.		
DC Characteristics						
Collector-base cutoff current	I _{CBO}	-	-	10	nA	
$V_{CB} = 5 \text{ V}, I_{E} = 0$						
Collector-emitter cutoff current 1.)	I _{CEX}	-	-	20	μΑ	
$V_{CE} = 4.5 \text{ V}, I_B = 0.1 \mu A$				(t.b.d.)		
Emitter-base cuttoff current	I _{EBO}	-	-	5.0	μΑ	
$V_{EB} = 1.5 \text{ V}, I_{C} = 0$						
DC current gain	h _{FE}	50	90	150	-	
$I_C = 5 \text{ mA}, V_{CE} = 1 \text{ V}$						

Notes:

1.) This Test assures V(BR)CE0 > 4.5V



Electrical Characteristics (continued)

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics	·				·
Transition frequency	f _T				GHz
$I_{C} = 10 \text{mA}, V_{CE} = 3 \text{ V}, f = 2.0 \text{ GHz}$		20	22	-	
Collector-base capacitance	ССВ	-	0.05	0.9	pF
$V_{CB} = 2 \text{ V}, V_{BE} = \text{vbe} = 0, f = 1 \text{ MHz}$					
Collector-emitter capacitance	C _{CE}	-	0.32	0.48	pF
$V_{CE} = 2 \text{ V}, V_{BE} = \text{vbe} = 0, f = 1 \text{ MHz}$					
Emitter-base capacitance	C _{EB}	-	0.36	3.0	pF
$V_{EB} = 0.5V$, $V_{CB} = vcb = 0$, $f = 1 MHz$					
Noise Figure	F	-	1.15	1.8	dB
$I_{C} = 2 \text{ mA}, V_{CE} = 2 \text{ V}, f = 1.8 \text{ GHz},$					
$Z_S = Z_{sopt}$					
Insertion power gain	$\left S_{21e}\right ^2$	14	18	-	dB
$I_C = 5 \text{ mA}, V_{CE} = 2 \text{ V}, f = 1.8 \text{ GHz}$					
$Z_S = Z_L = 50 \Omega$					
Power gain	Gms 1.)	-	23	-	dB
$I_C = 5 \text{ mA}, V_{CE} = 2 \text{ V}, f = 1.8 \text{ GHz}$					
$Z_S = Z_{Sopt}$, $Z_L = Z_{Lopt}$					
1dB Compression point	P _{-1dB}	-	5	-	dBm
$I_C = 5 \text{ mA}, V_{CE} = 2 \text{ V}, f = 1.8 \text{ GHz}$					
$Z_S = Z_{Sopt}$, $Z_L = Z_{Lopt}$					

Notes.:

$$G_{ms} = \frac{|S21|}{|S12|}$$



Order Instructions:

Full type variant including quality level must be specified by the orderer. For *HiRel* Discrete and Microwave Semiconductors the ordering code specifies device family and quality level.

Ordering Form:

Ordering Code: Q.....

BFY405 (ql)

(ql): Quality Level

Ordering Example:

Ordering Code: Q62702F1710

BFY405 ES

For BFY405 in ESA Space Quality Level

Further Informations:

See our WWW-Pages:

- Discrete and RF-Semiconductors (Small Signal Semiconductors) www.infineon.com/products/discrete/hirel.htm

 HiRel Discrete and Microwave Semiconductors www.infineon.com/products/discrete/hirel.htm

Please contact also our marketing division :

Tel.: ++89 234 24480 Fax.: ++89 234 28438

e-mail: martin.wimmers@infineon.com

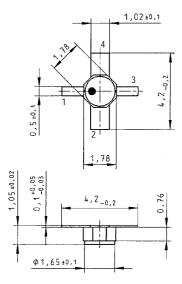
Address: Infineon Technologies Semiconductors,

High Frequency Products Marketing,

P.O.Box 801709, D-81617 Munich



Micro-X Package



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